

The minimum thickness of a double-sided

The minimum thickness of a double-sided (DS) board with plated (through) holes (PTHs) is regulated due to the fact that it is not possible to attach and process materials thinner than 0.36 mm in the vertical plating line!

This means that Brandner Electronics can manufacture boards, the (through) holes of which do not need to be plated, with a minimum thickness of 0.1 mm.

Please note that the material with a thickness of 0.1 mm is the inner layer used for manufacturing multilayer boards – i.e. 0.1 mm indicates the thickness of the isolation layer which is added the thickness of the copper foil from both sides.